

Form 1449*	Atty. Docket No.: 884.315US1	Serial No. Unknown
INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use several sheets if necessary)	Applicant: Kishore K. Chakravorty et al.	
	Filing Date: Herewith	Group: Unknown

U.S. PATENT DOCUMENTS

**Examiner Initial	Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
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✓	Chan, Y., et al., "Fabrication and Characterization of Multilayer Capacitors Buried in a Low Temperature Co-Fired Ceramic Substrate", <u>Active and Passive Elec. Comp. Vol. 20</u> , 215-224, (1998)
✓	Choi, K.L., et al., "Characterization of Embedded Passives Using Macromodels in LTCC Technology", <u>IEEE Transactions on Components, Packaging, and Manufacturing Technology, Vol. 21</u> , 258-268, (Aug. 1998)
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*Substitute Disclosure Statement Form (PTO-1449)

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Sheet 1 of 1

Form 1449*

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Applicant: Kishore K. Chakravorty et al.

Filing Date: August 30, 2000

Group: Unknown

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